

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kazuyuki Iwasaki</td> <td>12/03/2009</td> </tr> <tr> <td>Ryuichi Goto</td> <td>12/07/2009</td> </tr> <tr> <td>Shogo Sakuma</td> <td>12/09/2009</td> </tr> </tbody> </table>		Name	Execution Date	Kazuyuki Iwasaki	12/03/2009	Ryuichi Goto	12/07/2009	Shogo Sakuma	12/09/2009		
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CORRESPONDENCE DATA											
<p>Fax Number: (703)652-5101 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 703-778-6610 Email: MKishimoto@CKVNLaw.COM Correspondent Name: David J. Kenealy Address Line 1: 515 EAST BRADDOCK RD Address Line 4: Alexandria, VIRGINIA 22314</p>											
ATTORNEY DOCKET NUMBER:	ST3001-0231										
NAME OF SUBMITTER:	David J Kenealy										
<p>Total Attachments: 2 source=Assignment_for_G09-048US#page1.tif source=Assignment_for_G09-048US#page2.tif</p>											

OP \$40.00 12619773

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PATENT
REEL: 023690 FRAME: 0772

ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

METHOD FOR MANUFACTURING SEMICONDUCTOR APPARATUS AND MOLD ASSEMBLY FOR THE SAME

for which WE executed an application for United States Letters Patent concurrently herewith and for which WE filed Japanese Patent Application No. 2008-293469 on November 17, 2008; and

WHEREAS **STANLEY ELECTRIC CO., LTD.**, a corporation of Japan, whose post office address is 2-9-13 Nakameguro, Meguro-ku, Tokyo 153-8636 Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. 12/619,773, filed November 17, 2009) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

<u>Full Name of First Assignor</u> Kazuyuki IWASAKI	<u>Assignor's Signature</u> <i>Kazuyuki Iwasaki</i>	<u>Date</u> December 3, 2009
<u>Address:</u> c/o Stanley Electric Co., Ltd. 2-9-13, Nakameguro, Meguro-ku, Tokyo 153-8636 JAPAN		<u>Citizenship</u> Japan
Names of additional inventors attached <div style="float: right;"> <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No </div>		

Cermak Kenealy Vaidya & Nakajima LLP

<u>Full Name of Second Assignor</u> Ryuichi GOTO	<u>Assignor's Signature</u> <i>Ryuichi Goto</i>	<u>Date</u> <i>December 7, 2009</i>
<u>Address:</u> c/o Stanley Electric Co., Ltd. 2-9-13, Nakameguro, Meguro-ku, Tokyo 153-8636 JAPAN		<u>Citizenship:</u> Japan
<u>Full Name of Third Assignor</u> Shogo SAKUMA	<u>Assignor's Signature</u> <i>Shogo Sakuma</i>	<u>Date</u> <i>December 9, 2009</i>
<u>Address:</u> c/o Stanley Electric Co., Ltd. 2-9-13, Nakameguro, Meguro-ku, Tokyo 153-8636 JAPAN		<u>Citizenship:</u> Japan
<p>Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>		

Cermak Kenealy Vaidya & Nakajima LLP